



DYNAMIC RECOVERY CHARACTERISTICS ( $T_C = 25^\circ\text{C}$ unless otherwise specified)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Reverse recovery time	$t_{rr}$	$I_F = 1\text{ A}$ , $di_F/dt = 100\text{ A}/\mu\text{s}$ , $V_R = 30\text{ V}$	-	22	30	ns
		$I_F = 15\text{ A}$ , $di_F/dt = 100\text{ A}/\mu\text{s}$ , $V_R = 30\text{ V}$	-	28	35	
		$T_J = 25^\circ\text{C}$	-	29	-	
		$T_J = 125^\circ\text{C}$	-	75	-	
Peak recovery current	$I_{RRM}$	$T_J = 25^\circ\text{C}$	-	3.5	-	A
		$T_J = 125^\circ\text{C}$	-	7	-	
Reverse recovery charge	$Q_{rr}$	$T_J = 25^\circ\text{C}$	-	57	-	$\mu\text{C}$
		$T_J = 125^\circ\text{C}$	-	300	-	
Reverse recovery time	$t_{rr}$	$I_F = 15\text{ A}$ $di_F/dt = 800\text{ A}/\mu\text{s}$ $V_R = 390\text{ V}$	-	51	-	ns
Peak recovery current	$I_{RRM}$		-	20	-	A
Reverse recovery charge	$Q_{rr}$		-	580	-	nC

THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Maximum junction and storage temperature range	$T_J$ , $T_{Stg}$		-65	-	175	$^\circ\text{C}$
Thermal resistance, junction to case per leg	$R_{thJC}$		-	1.0	1.3	$^\circ\text{C}/\text{W}$
Thermal resistance, junction to ambient per leg	$R_{thJA}$	Typical socket mount	-	-	70	
Thermal resistance, case to heatsink	$R_{thCS}$	Mounting surface, flat, smooth and greased	-	0.5	-	
Weight			-	2.0	-	g
			-	0.07	-	oz.
Mounting torque			6.0 (5.0)	-	12 (10)	kgf · cm (lbf · in)
Marking device		Case style TO-263AB (D <sup>2</sup> PAK)	15ETH06S			
		Case style TO-262AA	15ETH06-1			

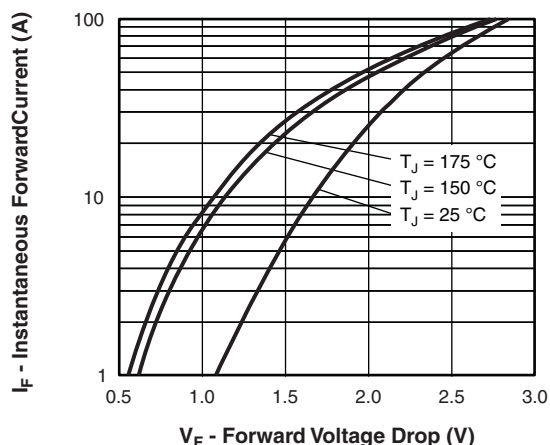


Fig. 1 - Typical Forward Voltage Drop Characteristics

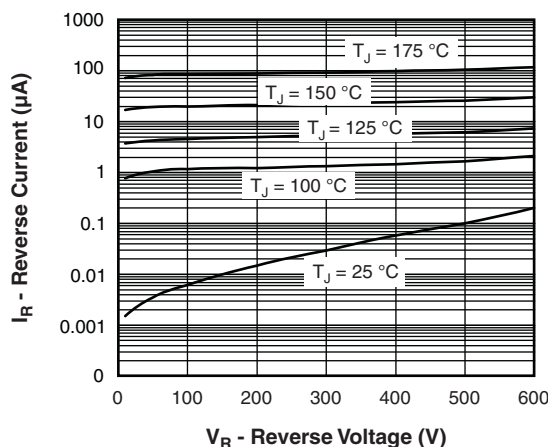


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

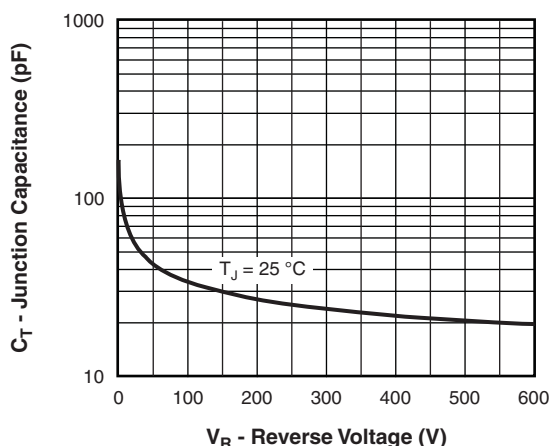


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

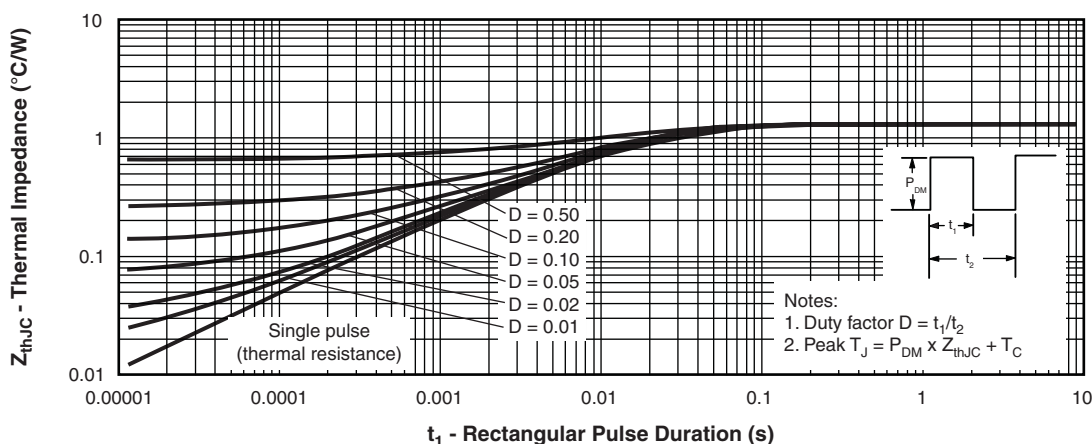
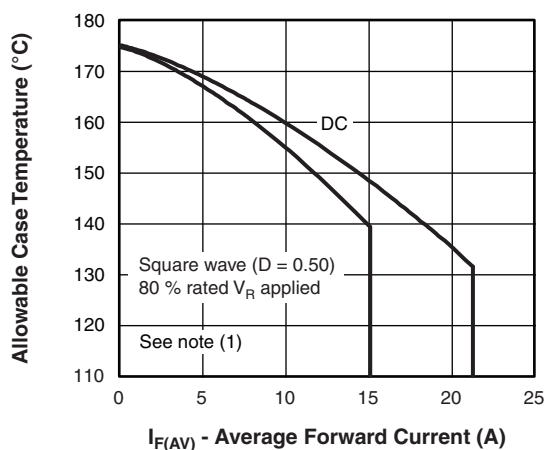

Fig. 4 - Maximum Thermal Impedance  $Z_{thJC}$  Characteristics


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current

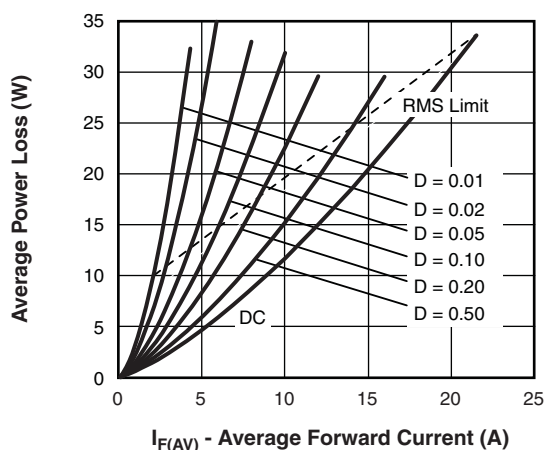


Fig. 6 - Forward Power Loss Characteristics

**Note**

- (1) Formula used:  $T_C = T_J - (P_d + P_{dREV}) \times R_{thJC}$ ;  
 $P_d$  = Forward power loss =  $I_{F(AV)} \times V_{FM}$  at  $(I_{F(AV)}/D)$  (see fig. 6);  
 $P_{dREV}$  = Inverse power loss =  $V_{R1} \times I_R (1 - D)$ ;  $I_R$  at  $V_{R1}$  = Rated  $V_R$

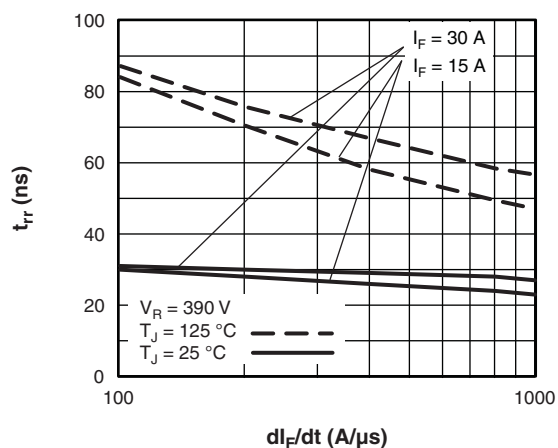
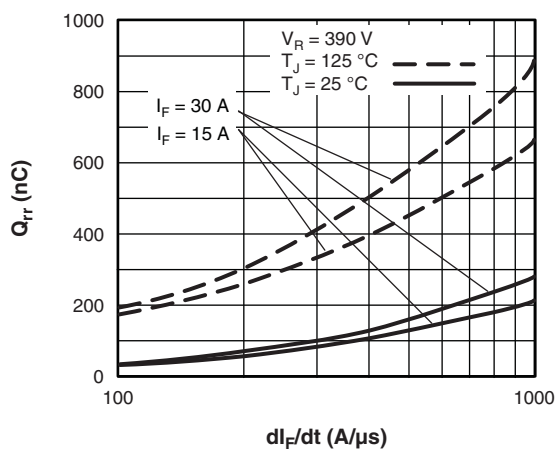
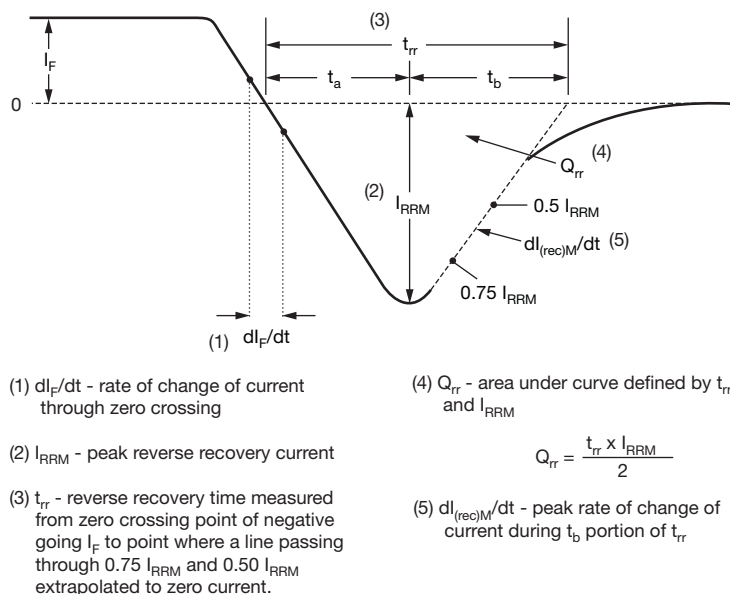

Fig. 7 - Typical Reverse Recovery vs.  $dI_F/dt$ 

Fig. 8 - Typical Stored Charge vs.  $dI_F/dt$ 


Fig. 9 - Reverse Recovery Waveform and Definitions



## ORDERING INFORMATION TABLE

Device code	VS-	15	E	T	H	06	S	TRL	PbF
	1	2	3	4	5	6	7	8	9

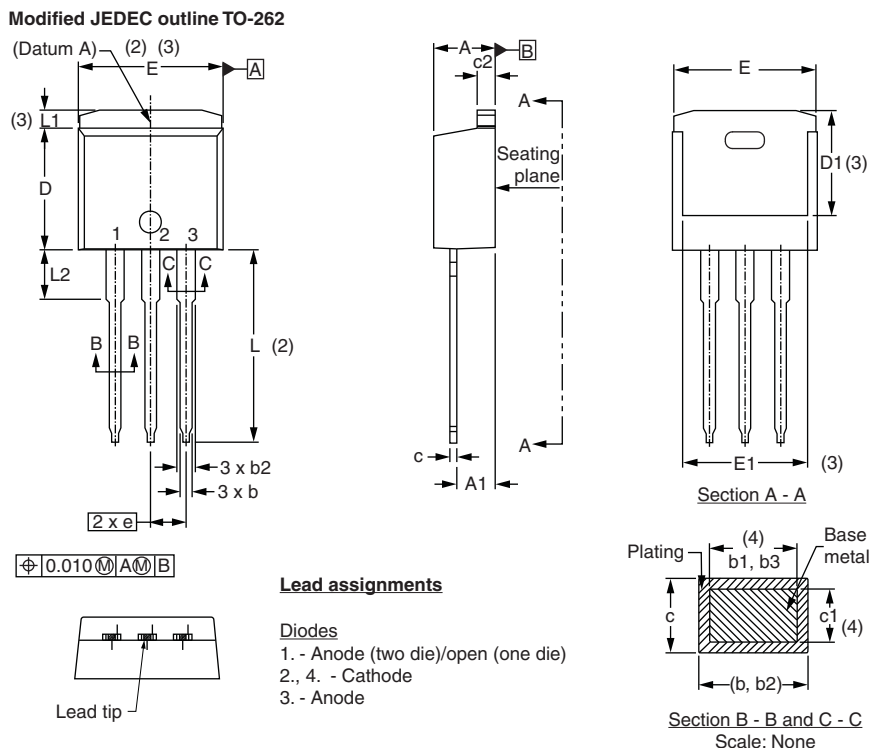
- |   |  |
|---|--|
| 1 | - Vishay Semiconductors product  |
| 2 | - Current rating (15 A)  |
| 3 | - E = single diode   |
| 4 | - T = TO-220, D <sup>2</sup> PAK   |
| 5 | - H = hyperfast rectifier  |
| 6 | - Voltage rating (06 = 600 V)  |
| 7 | - • S = D <sup>2</sup> PAK<br>• -1 = TO-262  |
| 8 | - • None = tube (50 pieces)<br>• TRL = tape and reel (left oriented, for D <sup>2</sup> PAK package)<br>• TRR = tape and reel (right oriented, for D <sup>2</sup> PAK package) |
| 9 | - PbF = lead (Pb)-free   |

ORDERING INFORMATION (Example)			
PREFERRED P/N	QUANTITY PER REEL	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION
VS-15ETH06SPBF	50	1000	Antistatic plastic tubes
VS-15ETH06TRRSPBF	800	800	13" diameter plastic tape and reel
VS-15ETH06STRLPBF	800	800	13" diameter plastic tape and reel
VS-15ETH06-1PBF	50	1000	Antistatic plastic tubes

LINKS TO RELATED DOCUMENTS		
Dimensions	TO-263AB (D <sup>2</sup> PAK)	<a href="http://www.vishay.com/doc?95046">www.vishay.com/doc?95046</a>
	TO-262AA	<a href="http://www.vishay.com/doc?95419">www.vishay.com/doc?95419</a>
Part marking information		<a href="http://www.vishay.com/doc?95008">www.vishay.com/doc?95008</a>
Packaging information		<a href="http://www.vishay.com/doc?95032">www.vishay.com/doc?95032</a>

Downloaded from [Arrow.com](http://Arrow.com).

## DIMENSIONS - TO-262 in millimeters and inches



SYMBOL	MILLIMETERS		INCHES		NOTES
	MIN.	MAX.	MIN.	MAX.	
A	4.06	4.83	0.160	0.190	
A1	2.03	3.02	0.080	0.119	
b	0.51	0.99	0.020	0.039	
b1	0.51	0.89	0.020	0.035	4
b2	1.14	1.78	0.045	0.070	
b3	1.14	1.73	0.045	0.068	4
c	0.38	0.74	0.015	0.029	
c1	0.38	0.58	0.015	0.023	4
c2	1.14	1.65	0.045	0.065	
D	8.51	9.65	0.335	0.380	2
D1	6.86	8.00	0.270	0.315	3
E	9.65	10.67	0.380	0.420	2, 3
E1	7.90	8.80	0.311	0.346	3
e	2.54 BSC		0.100 BSC		
L	13.46	14.10	0.530	0.555	
L1	-	1.65	-	0.065	3
L2	3.56	3.71	0.140	0.146	

### Notes

- (1) Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Controlling dimension: inches

- (6) Outline conform to JEDEC TO-262 except A1 (maximum), b (minimum) and D1 (minimum) where dimensions derived the actual package outline



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